

00862.022294



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)	
	:	Examiner: R. Zacharia
DAISHI SAIKI ET AL.)	
	:	Group Art Unit: 1773
Application No.: 09/897,014)	
	:	
Filed: July 3, 2001)	
	:	
For: MULTILAYERED STRUCTURE)	
RESIN MOLDED PRODUCT	:	
AND METHOD OF)	
MANUFACTURING	:	
MULTILAYERED STRUCTURE)	
RESIN MOLDED PRODUCT	:	October 15, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

STATEMENT OF THE SUBSTANCE OF INTERVIEW

Sir:

This Statement is filed in response to the Examiner's Interview Summary issued on September 13, 2004 in the above-identified application. The Examiner's Interview Summary summarized a telephonic interview conducted between the Examiner and Applicants' undersigned representative on or about August 24, 2004.

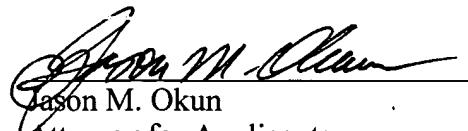
On or about August 24, 2004, the Examiner contacted Applicants' undersigned attorney and asked permission to cancel claims 32-34 in view of what the Examiner deemed to be an indefinite phrase "small-thickness portion". In lieu of the Examiner's proposed course of action, it was suggested that in order to address potential indefiniteness issues and to expedite prosecution, the Examiner may replace the phrase "small-thickness portion" with --groove or

cavity--, in accordance with Figs. 11-14 and the corresponding disclosure in the specification.

The Examiner agreed to make such a modification to claims 32-34 via an Examiner's Amendment.

Applicants' undersigned attorney may be reached in our New York office by telephone at (212) 218-2100. All correspondence should continue to be directed to our below listed address.

Respectfully submitted,



Jason M. Okun
Attorney for Applicants
Registration No.: 48,512

FITZPATRICK, CELLA, HARPER & SCINTO
30 Rockefeller Plaza
New York, New York 10112-3801
Facsimile: (212) 218-2200

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